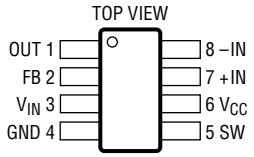
ABSOLUTE MAXIMUM RATINGS

(Note 1)

V_{IN} Voltage 16V
SW Voltage 40V
V_{CC} Voltage 38V
+IN, –IN Voltage 10V
FB Voltage 3V
Current Into SW Pin 1A
Operating Temperature Range (Note 2) .. –40°C to 85°C
Storage Temperature Range ..... –65°C to 150°C
Lead Temperature (Soldering, 10 sec)..... 300°C

PACKAGE/ORDER INFORMATION



TS8 PACKAGE
8-LEAD PLASTIC TSOT-23

T_{JMAX} = 125°C, θ_{JA} = 250°C/W

ORDER PART NUMBER
LT3469ETS8
TS8 PART MARKING
LTACA

Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. (Note 2) V_{IN} = 5V, V_{CC} = 35V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
g_m Amplifier						
Input Offset Voltage	V_{OUT} = V_{CC}/2	●		3	10	mV
Input Offset Current		●		10	100	nA
Input Bias Current		●		150	500	nA
Input Resistance—Differential Mode				1		MΩ
Input Resistance—Common Mode				200		MΩ
Common Mode Rejection Ratio	V_{CM} = 0V to 10V		70	100		dB
Power Supply Rejection Ratio—V_{IN}	V_{IN} = 2.5V to 16V		80	120		dB
Power Supply Rejection Ratio—V_{CC}	V_{CC} = 15V to 35V		65	85		dB
Gain	No Load, V_{OUT} = 2V to 33V R_L = 200k, V_{OUT} = 2V to 33V		15 10	30 20		V/mV V/mV
Transconductance	I_{OUT} = ±100µA	 ●	160 140	220	260 300	µA/mV µA/mV
Maximum Output Current	V_{OUT} = V_{CC}/2	 ●	±30 ±23	±40	±55 ±58	mA mA
Maximum Output Voltage, Sourcing	V_{CC} = 35V, I_{OUT} = 10mA V_{CC} = 35V, I_{OUT} = 0mA		34.0 34.5	34.5 34.9		V V
Minimum Output Voltage, Sinking	I_{OUT} = –10mA I_{OUT} = 0mA			200 10	1000 500	mV mV
Output Resistance	V_{CC} = 35V, V_{OUT} = 2V to 33V			100		kΩ
Supply Current—V_{CC}	V_{CC} = 35V		1.5	2	2.5	mA
Switching Regulator						
Minimum Operating Voltage					2.5	V
Maximum Operating Voltage			16			V
Feedback Voltage		●	1.19	1.23	1.265	V
FB Pin Bias Current		●		45	200	nA
FB Line Regulation	2.5V < V_{IN} < 16V			0.03		%/V
Supply Current—V_{IN}				1.9	2.6	mA
Switching Frequency		●	0.8	1.3	1.7	MHz
Maximum Duty Cycle		●	88	91		%
Switch Current Limit (Note 3)		●	165	220		mA
Switch V_{CESAT}	I_{SW} = 100mA			350	500	mV

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. (Note 2) V_{IN} = 5V, V_{CC} = 35V, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Switch Leakage Current	V_{SW} = 5V			0.01	1	µA
Diode V_F	I_D = 100mA			740	1100	mV
Diode Reverse Leakage Current	V_R = 5V			0.1	1	µA

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

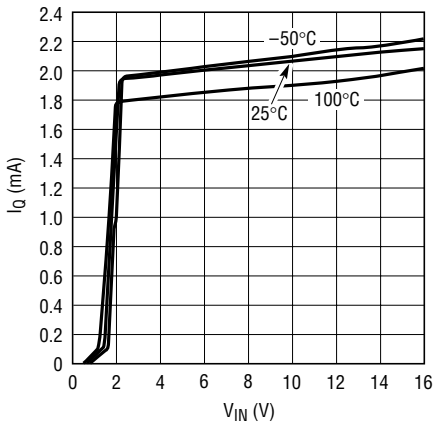
Note 2: The LT3469E is guaranteed to meet performance specifications from 0°C to 85°C. Specifications over the –40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: Current limit is guaranteed by design and/or correlation to static test. Slope compensation reduces current limit at higher duty cycles.

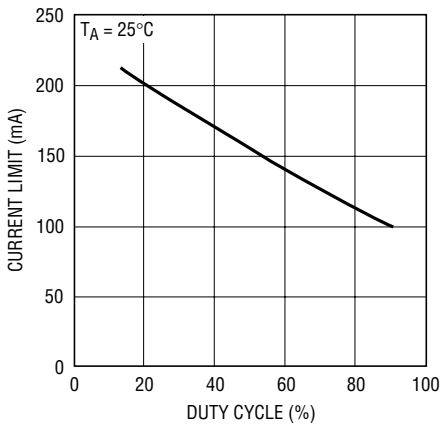
TYPICAL PERFORMANCE CHARACTERISTICS

(Switching Regulator)

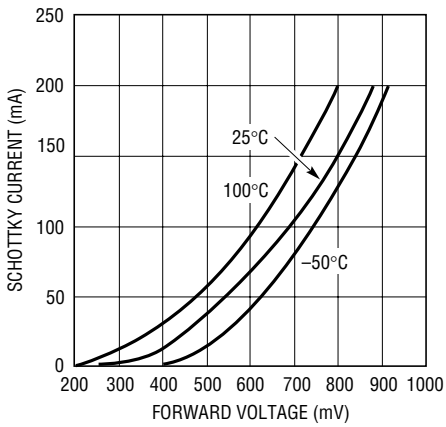
V_{IN} Quiescent Current



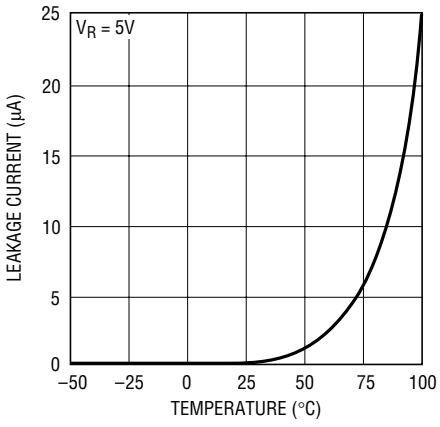
Current Limit vs Duty Cycle



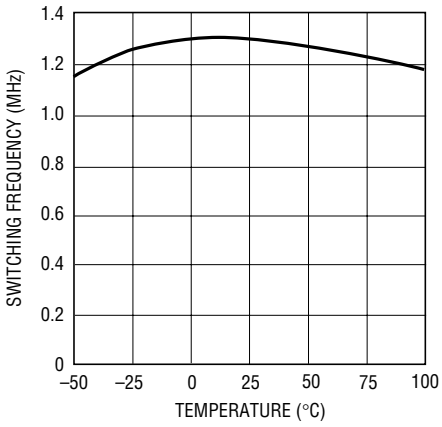
Schottky Forward Voltage



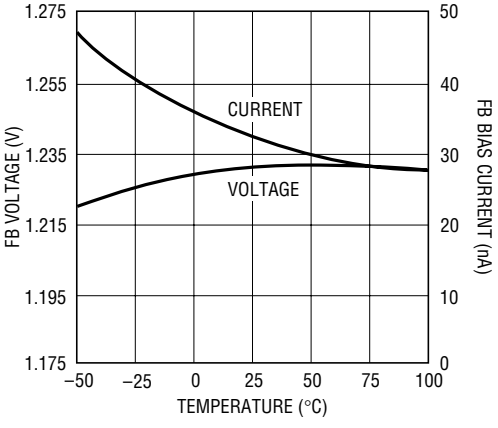
Schottky Reverse Leakage



Switching Frequency



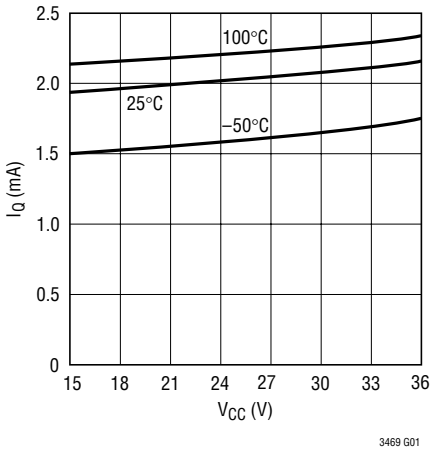
FB Pin Voltage and Bias Current



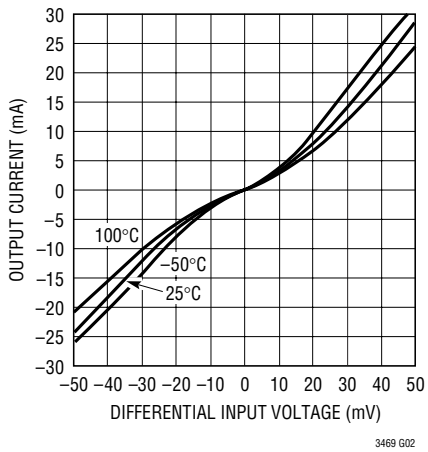
TYPICAL PERFORMANCE CHARACTERISTICS

(g_m Amplifier)

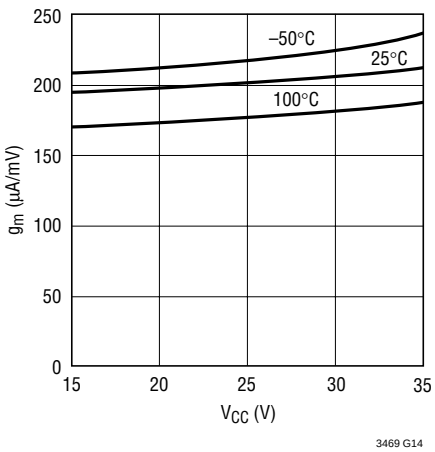
V_{CC} Quiescent Current



Output Current vs Differential Input Voltage



g_m vs V_{CC}



PIN FUNCTIONS

OUT (Pin 1): Output of the g_m Amplifier. There must be at least 5nF of capacitive load at the output in a gain of 10 configuration. Capacitive loads up to 300nF can be connected to this pin. Piezo actuators below 5nF can be driven if capacitance is placed in parallel to bring the total capacitance to 5nF.

FB (Pin 2): Feedback Pin. Reference voltage is 1.23V. Connect feedback resistor divider here.

V_{IN} (Pin 3): Input Supply Pin. Must be locally bypassed.

GND (Pin 4): Ground Pin. Connect directly to local ground plane.

SW (Pin 5): Switch Pin. Connect inductor here. Minimize trace area at this pin to reduce EMI.

V_{CC} (Pin 6): Output of Switching Regulator and Supply Rail for g_m Amp. There must be 0.22µF or more of capacitance here.

+IN (Pin 7): Noninverting Terminal of the g_m Amplifier.

–IN (Pin 8): Inverting Terminal of the g_m Amplifier.

BLOCK DIAGRAM

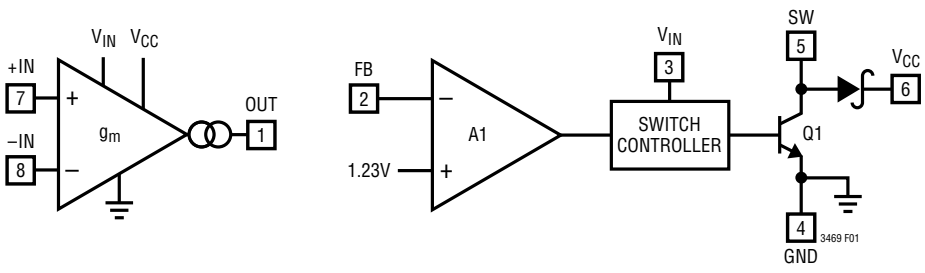


Figure 1. LT3469 Block Diagram

OPERATION

g_m Amplifier

The LT3469 is a wide output voltage range g_m amplifier designed to drive capacitive loads. Input common mode range extends from 10V to ground. The output current is proportional to the voltage difference across the input terminals. When the output voltage has settled, the input terminals will be at the same voltage; supply current of the amplifier will be low and power dissipation will be low. If presented with an input differential, however, the output current can increase significantly, up to the maximum output current (typically 40mA). The output voltage slew rate is determined by the maximum output current and the output capacitance, and can be quite high. With a 10nF load, the output slew rate will typically be 4V/µs. The capacitive load compensates the g_m amplifier and must be present for stable operation. The gain capacitance product of the amplifier must be at least 50nF. For example, if the amplifier is operated in a gain of 10 configuration, a minimum capacitance of 5nF is necessary. In a gain of 20 configuration, a minimum of 2.5nF is necessary. Closed loop –3dB bandwidth is set by the output capacitance. Typical closed loop bandwidth is approximately:

$$\frac{g_m}{2\pi \bullet A_V \bullet C_{OUT}}$$

where g_m = 200µA/mV

For example, an amplifier in a gain of 10 configuration with 10nF of output capacitance will have a closed loop –3dB bandwidth of approximately 300kHz. Figure 3 shows typical bandwidth of a gain of 10 configuration per output capacitance.

In applications where negative phase contributions below crossover frequency must be minimized, a phase boost capacitor can be added, as shown in Figure 4. Larger values of C_{BOOST} will further reduce the closed-loop negative phase contribution, however, the amplifier phase margin will be reduced. For an amplifier phase margin of approximately 55°, select C_{BOOST} as follows:

$$C_{BOOST} = \frac{C_{OUT}(R1/R2+1)}{g_m(R1||R2)}$$

where g_m = 200µA/mV.

In a gain of 10 configuration, choosing C_{BOOST} as described will lead to nearly zero closed-loop negative phase contribution at 3kHz for values of C_{OUT} from 10nF to 200nF. The phase boost capacitor should not be used if C_{OUT} is less than twice the minimum for stable operation. The gain capacitance product should therefore be higher than 100nF if a phase boost capacitor is used.

Switching Regulator

The LT3469 uses a constant frequency, current mode control scheme to provide excellent line and load regulation. Operation can be best understood by referring to the Block Diagram in Figure 1. The switch controller sets the peak current in Q1 proportional to its input. The input to the switch controller is set by the error amplifier, A1, and is

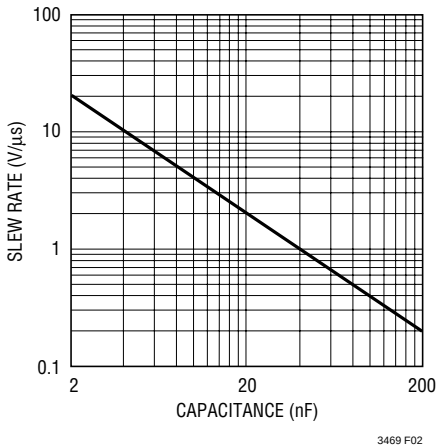


Figure 2. Slew Rate vs Capacitance

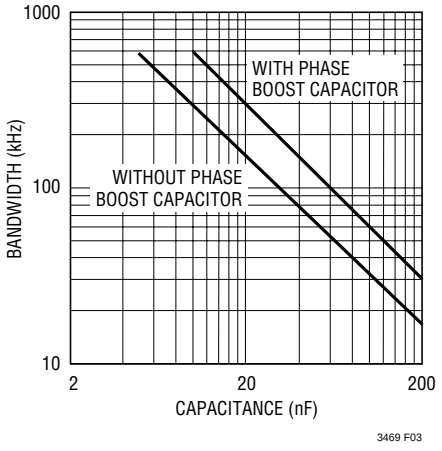


Figure 3. Closed Loop –3dB Bandwidth vs Capacitance in a Gain of 10 Configuration

OPERATION

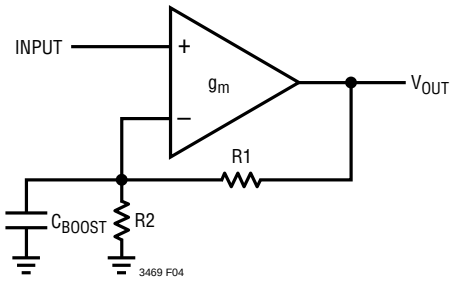


Figure 4. Boosting the Bandwidth of the g_m Amplifier with Capacitance On the Inverting Input

simply an amplified version of the difference between the feedback voltage and the reference voltage of 1.23V. In this manner, the error amplifier sets the correct peak current level to keep the output in regulation. If the error amplifier's output increases, more current is delivered to the output; if it decreases, less current is delivered. The switching regulator provides the boosted supply voltage for the g_m amplifier.

Inductor Selection

A 47µH inductor is recommended for most LT3469 applications. Some suitable inductors with small size are listed in Table 1. The efficiency comparison of different inductors is shown in Figure 5.

Table 1. Recommended Inductors

PART NUMBER	DCR (Ω)	CURRENT RATING (mA)	MANUFACTURER
LQH32CN470	1.3	170	Murata 814-237-1431 www.murata.com
CMD4D11-470	2.8	180	Sumida 847-545-6700 www.Sumida.com
LBC2518T470M	1.9	150	Taiyo Yuden 408-573-4150 www.t-yuden.com

Capacitor Selection

The small size of ceramic capacitors makes them ideal for LT3469 applications. X5R and X7R types are recommended because they retain their capacitance over wider voltage and temperature ranges than other types such as Y5V or Z5U. A 1µF input capacitor is sufficient for most LT3469 applications. A 0.22µF output capacitor is sufficient for stable

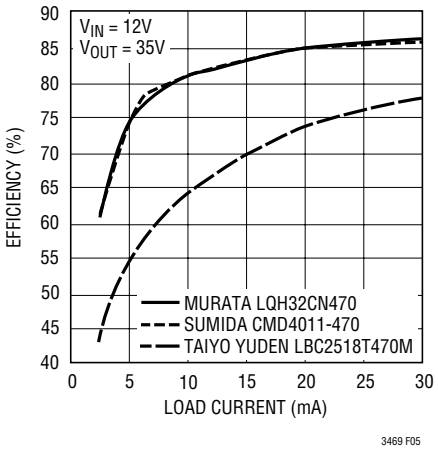


Figure 5. Efficiency Comparison of Different Inductors

transient response, however, more output capacitance can help limit the voltage droop on V_{CC} during transients.

Table 2. Recommended Ceramic Capacitor Manufacturers

MANUFACTURER	PHONE	URL
Taiyo Yuden	408-573-4150	www.t-yuden.com
AVX	843-448-9411	www.avxcorp.com
Murata	814-237-1431	www.murata.com
Kemet	408-986-0424	www.kemet.com

Inrush Current Considerations When Hot Plugging

When the supply voltage is applied to V_{IN}, the voltage difference between V_{IN} and V_{CC} generates inrush current flowing from the input through the inductor, the SW pin, and the integrated Schottky diode to charge the output capacitor. Care should be taken not to exceed the LT3469 maximum SW pin current rating of 1A. Worst-case inrush current occurs when the application circuit is hot plugged into a live supply with a large output capacitance. The typical application circuit will maintain a peak SW pin current below 1A when it is hot plugged into a 5V supply. To keep SW pin current below 1A during a hot plug into a 12V supply, 4.7Ω must be added between the supply and the LT3469 input capacitor. During normal operation, the SW pin current remains significantly less than 1A.

Layout Hints

As with all switching regulators, careful attention must be paid to the PCB board layout and component placement. To maximize efficiency, switch rise and fall times are made

OPERATION

as short as possible. To prevent electromagnetic interference (EMI) problems, proper layout of the high frequency switching path is essential. The voltage signal of the SW pin has sharp rise and fall edges. The SW pin should be surrounded on three sides by metal connected to V_{CC} to shield +IN and –IN. Minimize the area of all traces connected to the SW pin and always use a ground plane under the switching regulator to minimize interplane coupling. In addition, the ground connection for the feedback resistor R1 should be tied directly to the GND pin and not shared with any other component, ensuring a clean, noise-free connection. The ground return of the piezoceramic microactuator should also have a direct and unshared connection to the GND pin. The GND connection to R5 should be tied directly to the ground of the source generating the INPUT signal to avoid error induced by voltage drops along the GND line. Recommended component placement is shown in Figure 6.

Thermal Considerations and Power Dissipation

The LT3469 combines large output drive with a small package. Because of the high supply voltage capability, it is possible to operate the part under conditions that exceed the maximum junction temperature. Maximum junction temperature (T_J) is calculated from the ambient temperature (T_A) and power dissipation (P_D) as follows:

$$T_J = T_A + (P_D \bullet 250°C/W)$$

Worst-case power dissipation occurs at maximum output swing, frequency, capacitance and V_{CC}. For a square wave input, power dissipation is calculated from the amplifier quiescent current (I_Q), input frequency (f), output swing ($V_{OUT(P-P)}$), capacitive load (C_L), amplifier supply voltage (V_{CC}) and switching regulator efficiency (η) as follows:

$$P_D = \frac{(I_Q + fV_{OUT(P-P)}C_L)(V_{CC})}{\eta}$$

Example: LT3469 at T_A = 70°C, V_{CC} = 35V, C_L = 200nF, f = 3kHz, $V_{OUT(P-P)}$ = 4V, η = 80%:

$$P_D = \frac{(2.5mA + 3kHz \bullet 4V \bullet 200nF)(35V)}{0.80} = 214mW$$

$$T_J = 70°C + (214mW \bullet 250°C/W) = 124°C$$

Do not exceed the maximum junction temperature of 125°C.

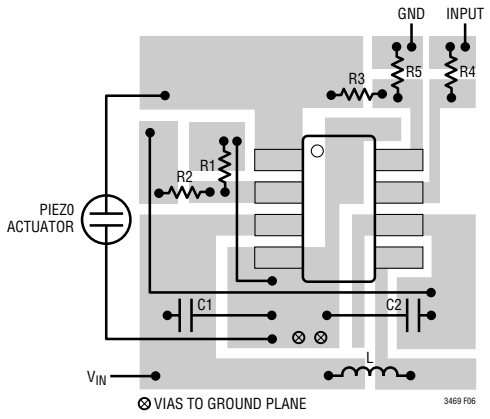
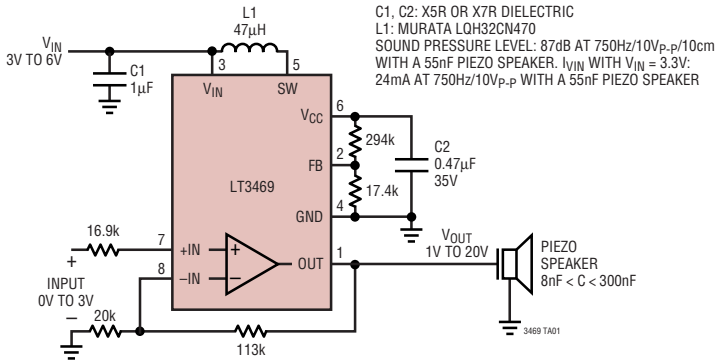


Figure 6. Recommended Component Placement

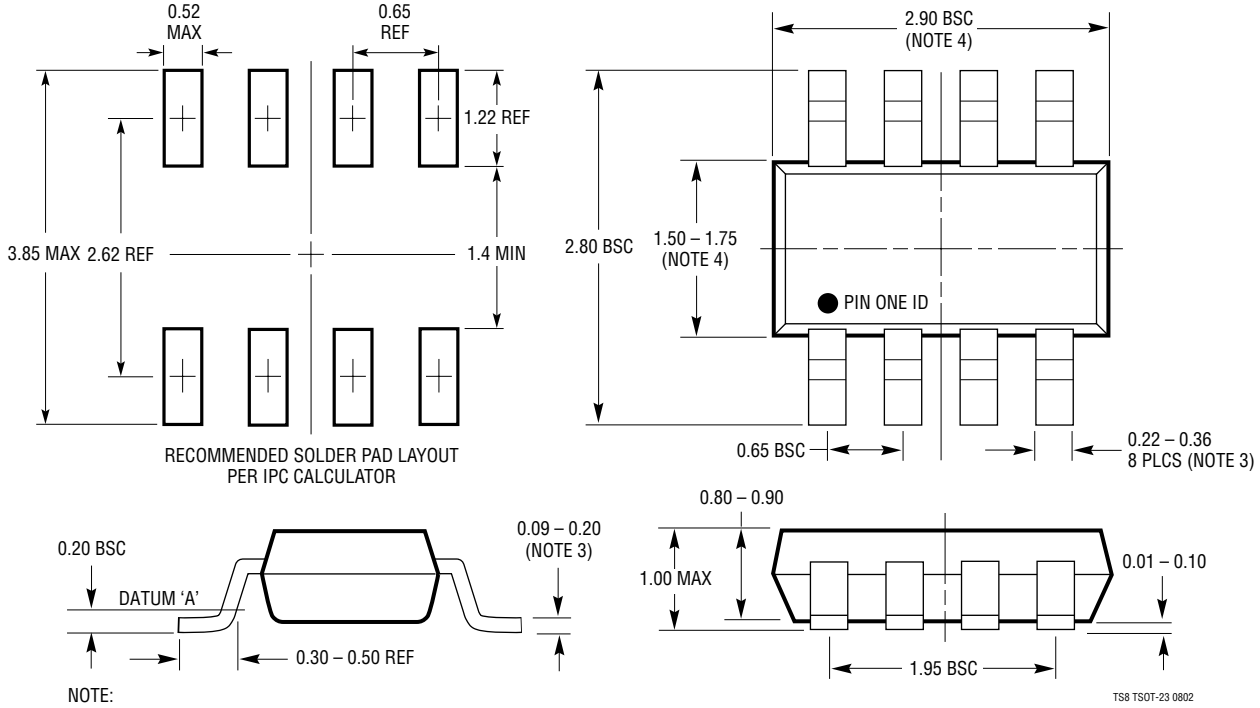
TYPICAL APPLICATION

Piezo Speaker Driver



PACKAGE DESCRIPTION

TS8 Package
8-Lead Plastic TSOT-23
(Reference LTC DWG # 05-08-1637)



NOTE:
1. DIMENSIONS ARE IN MILLIMETERS
2. DRAWING NOT TO SCALE
3. DIMENSIONS ARE INCLUSIVE OF PLATING
4. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR
5. MOLD FLASH SHALL NOT EXCEED 0.254mm
6. JEDEC PACKAGE REFERENCE IS MO-193

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1611	550mA I_{SW}, 1.4MHz, High Efficiency Inverting DC/DC Converter	V_{IN}: 0.9V to 10V, $V_{OUT(MAX)}$: 34V, I_Q: 3mA, I_{SD}: <1µA, ThinSOT
LT1616	600mA I_{OUT}, 1.4MHz, High Efficiency Step-Down DC/DC Converter	V_{IN}: 3.6V to 25V, $V_{OUT(MIN)}$: 1.25V, I_Q: 1.9mA, I_{SD}: <1µA, ThinSOT
LTC1772B	550kHz, Current Mode Step-Down DC/DC Controller	V_{IN}: 2.5V to 9.8V, $V_{OUT(MIN)}$: 0.8V, I_Q: 270µA, I_{SD}: <8µA, ThinSOT
LT1931/LT1931A	1A I_{SW}, 1.2MHz/2.2MHz, High Efficiency Inverting DC/DC Converter	V_{IN}: 2.6V to 16V, $V_{OUT(MAX)}$: –34V, I_Q: 4.2mA, I_{SD}: <1µA, ThinSOT
LT1940 (Dual)	Dual Output 1.4A I_{OUT}, Constant 1.1MHz, High Efficiency Step-Down DC/DC Converter	V_{IN}: 3V to 25V, $V_{OUT(MIN)}$: 1.2V, I_Q: 2.5mA, I_{SD}: <1µA, TSSOP-16E
LTC3411	1.25A I_{OUT}, 4MHz Synchronous Step-Down DC/DC Converter	V_{IN}: 2.5V to 5.5V, $V_{OUT(MIN)}$: 0.8V, I_Q: 60µA, I_{SD}: <1µA, MS10, DFN
LT3464	85mA I_{SW}, Constant Off-Time, High Efficiency Step-Up DC/DC Converter with Integrated Schottky and Output Disconnect	V_{IN}: 2.3V to 10V, $V_{OUT(MAX)}$: 34V, I_Q: 25µA, I_{SD}: <0.5µA, ThinSOT

Linear Technology Corporation
1630 McCarthy Blvd., Milpitas, CA 95035-7417
(408) 432-1900 • FAX: (408) 434-0507 • www.linear.com
LT/TP 0304 1K • PRINTED IN USA